

2N6236-2N6241

SILICON CONTROLLED RECTIFIERS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Repetitive peak forward and reverse blocking voltage (1)			
$(1/2 \text{ sine wave, } R_{GK} = 1000\Omega, T_{C} = -40 \text{ to } +110^{\circ}\text{C})$			
2N6236		30	
2N6237	V_{DRM}	50	Volts
2N6238	V_{RRM}	100	VOILS
2N6239		200	
2N6240		400	
2N6241		600	
Non-repetitive peak reverse blocking voltage			
$(1/2 \text{ sine wave, } R_{GK} = 1000\Omega, T_{C} = -40 \text{ to } +110^{\circ}\text{C})$			
2N6236		50	
2N6237	V_{RSM}	100	Volts
2N6238	▼ K2M	150	Voits
2N6239		250	
2N6240		450	
2N6241		650	
Average on-state current			
$(T_C = -40 \text{ to } +90^{\circ}\text{C})$	I _{T(AV)}	2.6	Amps
(T _C = 100°C)		1.6	
Surge on-state current			
$(1/2 \text{ sine wave, } 60 \text{Hz, } T_C = 90^{\circ}\text{C})$	I _{TSM}	25	Amps
$(1/2 \text{ sine wave, } 1.5 \text{ms, } T_C = 90^{\circ}\text{C})$		35	
Circuit fusing (T _C = -40 to +110°C, t = 8.3ms)	I ² t	2.6	A ² s
Peak gate power (pulse width = 10μs, T _C = 90°C)	P _{GM}	0.5	Watts
Average gate power (t = 8.3ms, T _C = 90°C)	P _{G(AV)}	0.1	Watts
Peak forward gate current	I _{GM}	0.2	Amps
Peak reverse gate voltage	V_{RGM}	6	Volts
Operating junction temperature range	T _J	-40 to 110	°C
Storage temperature range	T _{stg}	-40 to 150	°C
Stud torque		6	In. lb.

Note 1: Ratings apply for zero or negative gate voltage. Devices shall not have a positive bias applied to the gate concurrently with a negative potential on the anode. Devices should not be tested with a constant source for forward or reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal resistance, junction to case	R _{eJC}	3	°C/W
Thermal resistance, junction to ambient	R _{OJA}	75	°C/W



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ELECTRICAL CHARACTERISTICS (T_C = 25°C, R_{GK} = 1000 Ω unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak forward or reverse blocking current					
(Rated V _{DRM} or V _{RRM})					
$T_C = 25^{\circ}C$	I _{DRM} , I _{RRM}	-	-	10	μΑ
$T_C = 110$ °C		-	-	200	
Peak forward "on" voltage					
(I_{TM} = 8.2A peak, pulse width = 1 to 2ms, 2% duty cycle)	V _{TM}	-	-	2.2	Volts
Gate trigger current (continuous dc)	I _{GT}				μΑ
$(V_{AK} = 12Vdc, R_L = 24\Omega)$		-	-	200	
$(V_{AK} = 12Vdc, R_L = 24\Omega, T_C = -40^{\circ}C)$		-	-	500	
Gate trigger voltage (continuous dc)	V _{GT}				Volts
(Source voltage = 12V, $R_S = 50\Omega$)		-	-	1	
$(V_{AK} = 12Vdc, R_L = 24\Omega, T_C = -40^{\circ}C)$					
Gate non-trigger voltage	V_{GD}				Volts
(V_{AK} = rated V_{DRM} , R_L = 100 Ω , T_C = 110°C)		0.2	-	-	
Holding current	I _H				mA
$(V_{AK} = 12Vdc, I_{GT} = 2mA)$					
(initiating on state current = 200mA)					
$T_C = 25^{\circ}C$		-	-	5	
$T_c = -40$ °C		-	-	10	
Total turn-on time	t _{gt}				μs
(Source voltage = 12V, $R_S = 6k\Omega$)		-	-	2	
$(I_{TM} = 8.2A, I_{GT} = 2mA, rated V_{DRM})$					
(Rise time = 20ns, pulse width = 10μ s)					
Forward voltage application rate	dv/dt				V/µs
$(V_D = Rated V_{DRM}, T_C = 110^{\circ}C)$		-	10	-	



MECHANICAL CHARACTERISTICS

Case:	TO-126	
Marking:	Body painted, alpha-numeric	
Pin out:	See below	

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		T0	-126	
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.425	0.435	10.80	11.050
В	0.295	0.305	7.490	7.750
C	0.095	0,105	2.410	2.670
D	0.020	0.026	0.510	0.660
F	0.115	0.125	2.920	3.180
G	0.091	0.097	2.310	2.460
H	0.050	0.095	1.270	2.410
J	0.015	0.025	0.380	0.640
K	0.595	0.655	15.110	16.640
M	3°	TYP	3° TYP	
Q	0.148	0.158	3.760	4.010
R	0.045	0.055	1.140	1.400
S	0.025	0.035	0.640	0.890
U	0.145	0,155	3.680	3.940
٧	0.040		1.020	.55



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